

MOS FIELD EFFECT TRANSISTOR

2SK3431

SWITCHING

N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3431 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance:
- $R_{DS(on)1} = 5.6 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 42 \text{ A})$
- $R_{\text{DS(on)2}}$ = 8.9 m Ω MAX. (Vgs = 4 V, ID = 42 A)
- Low Ciss: $C_{iss} = 6100 \, pF \, TYP$.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	40	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±83	А
Drain Current (pulse) Note1	D(pulse)	±332	А
Total Power Dissipation (Tc = 25° C)	Рт	100	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	Ρτ	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	AS	65	А
Single Avalanche Energy Note2	Eas	423	mJ

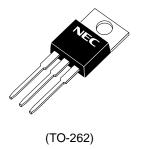
Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = 20 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3431	TO-220AB
2SK3431-S	TO-262
2SK3431-ZJ	TO-263
2SK3431-Z	TO-220SMD ^{Note}

Note TO-220SMD package is produced only in Japan.





(TO-263, TO-220SMD)



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(TO-220AB)

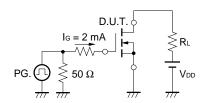
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 40 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 V$, $V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 V, I_{D} = 1 mA$	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = 10 V, I_D = 42 A$	30	60		s
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 10 V, I_D = 42 A$		4.5	5.6	mΩ
	RDS(on)2	$V_{GS} = 4 V, I_D = 42 A$		6.2	8.9	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		6100		pF
Output Capacitance	Coss	V _{GS} = 0 V		1400		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		700		pF
Turn-on Delay Time	td(on)	Vdd = 20 V, Id = 42 A		120		ns
Rise Time	tr	V _{GS} = 10 V		1800		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		350		ns
Fall Time	tr			440		ns
Total Gate Charge	QG	V _{DD} = 32 V		110		nC
Gate to Source Charge	QGS	V _{GS} = 10 V		18		nC
Gate to Drain Charge	Qgd	ID = 83 A		31		nC
Body Diode Forward Voltage	VF(S-D)	IF = 83 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 83 A, VGS = 0 V		65		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		110		nC

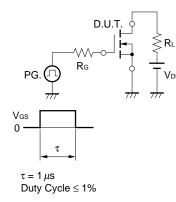
TEST CIRCUIT 1 AVALANCHE CAPABILITY

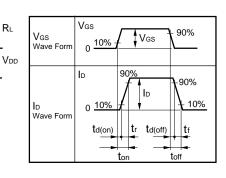
PG. $V_{GS} = 20 \rightarrow 0 \text{ V}$ V_{TT} V_{TT}

TEST CIRCUIT 3 GATE CHARGE

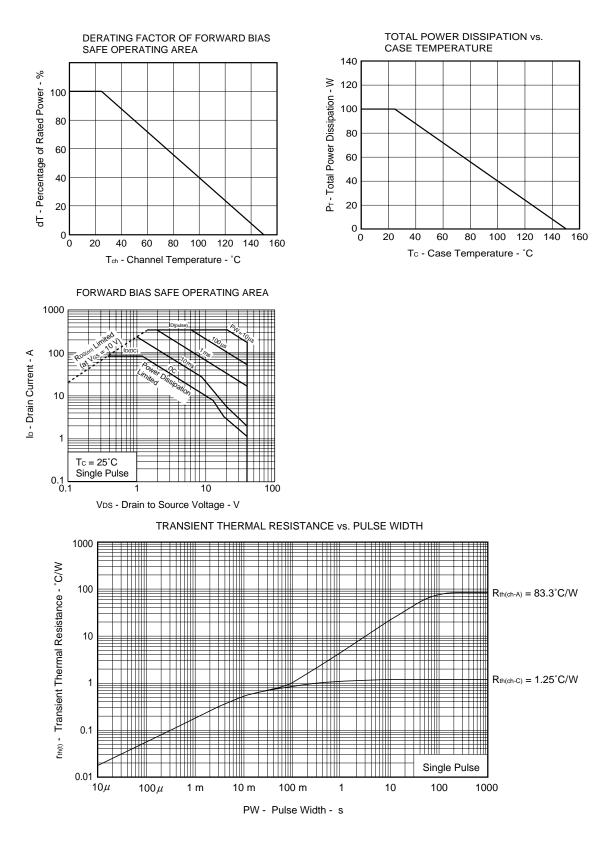


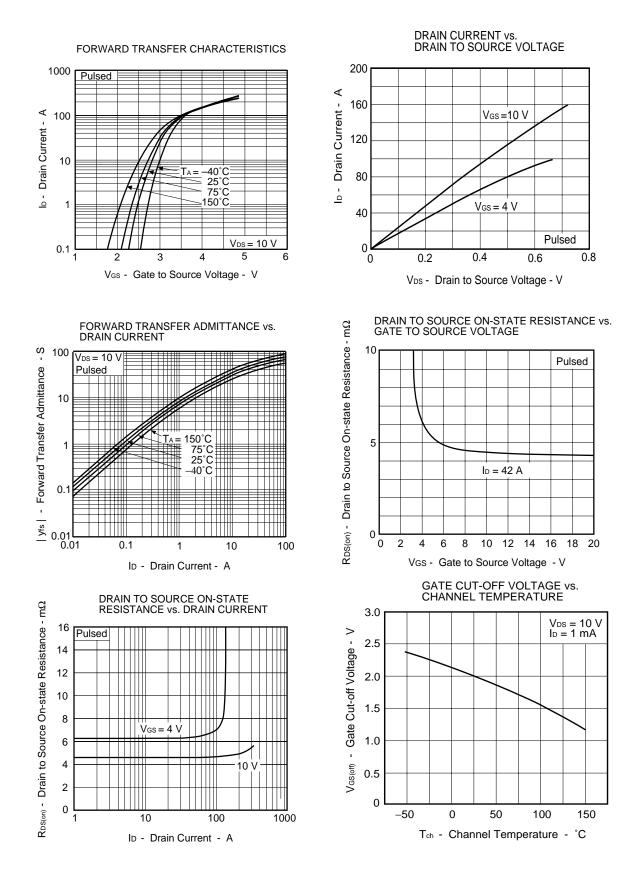
TEST CIRCUIT 2 SWITCHING TIME

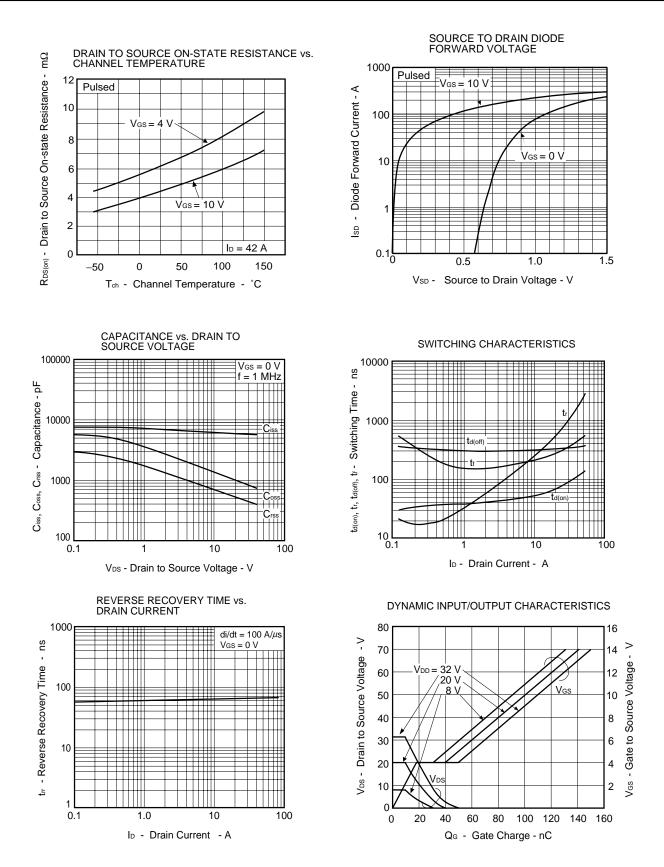


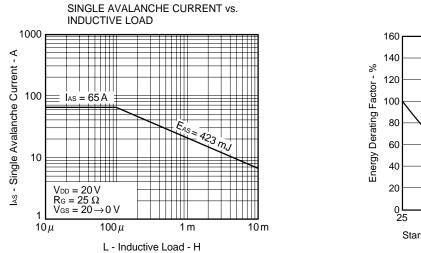


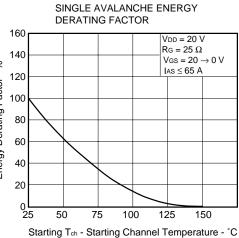
TYPICAL CHARACTERISTICS (TA = 25°C)





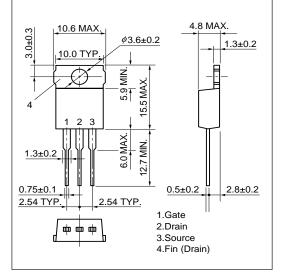




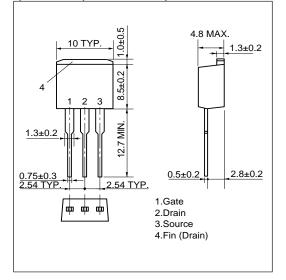


* PACKAGE DRAWINGS (Unit: mm)

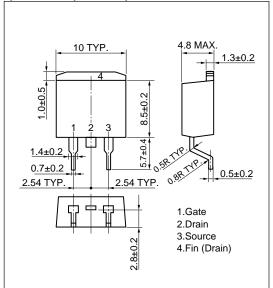
1) TO-220AB (MP-25)



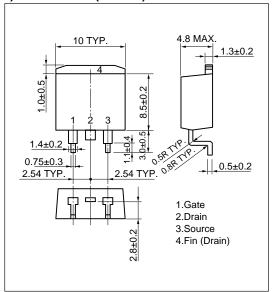
2) TO-262 (MP-25 Fin Cut)



3) TO-263 (MP-25ZJ)



4) TO-220SMD (MP-25Z) Note

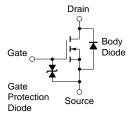


Note This package is produced only in Japan.

Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

EQUIVALENT CIRCUIT



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